

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Inventor: Radha Sen                      Group Art Unit: 1714  
Serial No.: 10/789963                      Examiner: T. Yoon  
Filed: February 27, 2004

Title: A System and a Method for Forming a Heat-Fusible  
Microporous Ink-Receptive Coating

Assistant Commissioner of Patents  
Washington, D.C. 20231

**PRELIMINARY AMENDMENT**

Dear Sir:

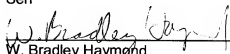
In response to the Office Action of January 26, 2007, the applicant  
elects, with traverse, Group II, claims 48, 49, 51-53, 55-58, 71 and 72.  
Group I (claims 1-10, 78 and 79), Group III (claim 54) and Group IV  
(claims 73-77) are hereby withdrawn.

Applicant requests that the above-elected claims be allowed.

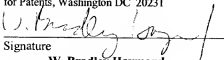
Respectfully submitted,

Sen

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I hereby certify that this correspondence is  
being deposited on **February 26, 2007**, with the  
United States Postal Service as first class mail in an  
envelope addressed to: Assistant Commissioner  
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Signature  
**W. Bradley Haymond**

Typed Name  
**February 26, 2007**

Date of Signature